



# NT4H1321

## NTAG 413 DNA Secure Unique NFC Message for direct access to web services

Rev. 3.2 — 12 October 2017  
400232

Product short data sheet  
COMPANY PUBLIC

## 1 Introduction

NTAG 413 DNA revolutionizes NTAG product portfolio by bringing AES cryptographic authentication and allows to automatically and securely connect to a web service by just tapping the tag without the need of a dedicated app installed on the mobile NFC device.

Besides the NXP originality signature and a 3-pass mutual authentication, it introduces a novel security feature called “Secure Unique NFC Message (SUN)”, which automatically generates tap-unique tag authentication data upon each read-out what enables dedicated unique communication to each user based on predefined criteria. No app (in NFC device) is required to generate this tap-unique data consisting of CMACed information derived from the chip UID, a tap counter and contained data. An NFC enabled device can automatically connect to a web based service and based on the information contained in URL, the device can check the tags authenticity and verify the information validity. NTAG 413 DNA offers flexibility to individualize the structure of this unique data set.

NTAG 413 DNA is an ideal solution to engage with consumers through dynamic content experiences, fully triggered by them and served in real-time. By that it enables smarter marketing based on ongoing contextual and unique consumer engagement opportunities in a secure way. Applications include but are not limited to consumer engagement, brand protection, access control, one-time vouchers and similar use cases where the proof of uniqueness, originality and physical tag presence are required.

NTAG 413 DNA is certified as NFC Forum Type 4 Tag [\[Certification ID: 58515\]](#) [\[15\]](#) and is also compliant to ISO/IEC14443-4 [\[4\]](#), ISO/IEC 7816-4 [\[7\]](#) file structure and APDUs format. Thanks to the high input capacitance (70pF), NTAG 413 DNA tag IC is particularly tailored for applications requiring small footprints, without compromise on performance. Small NFC tags can be more easily embedded into e.g. product labels or electronic devices. The mechanical and electrical specifications of NTAG 413 DNA is tailored to meet the requirements of inlay and tag manufacturer.

### 1.1 Contactless energy and data transfer

Communication to NTAG 413 DNA can be established only when the IC is connected to an antenna. Any form factor and antenna class type according to ISO/IEC 14443-1 [\[1\]](#) is possible to design with NTAG 413 DNA ICs. Few antenna design examples with guidelines are in NTAG antenna design application note [\[12\]](#).



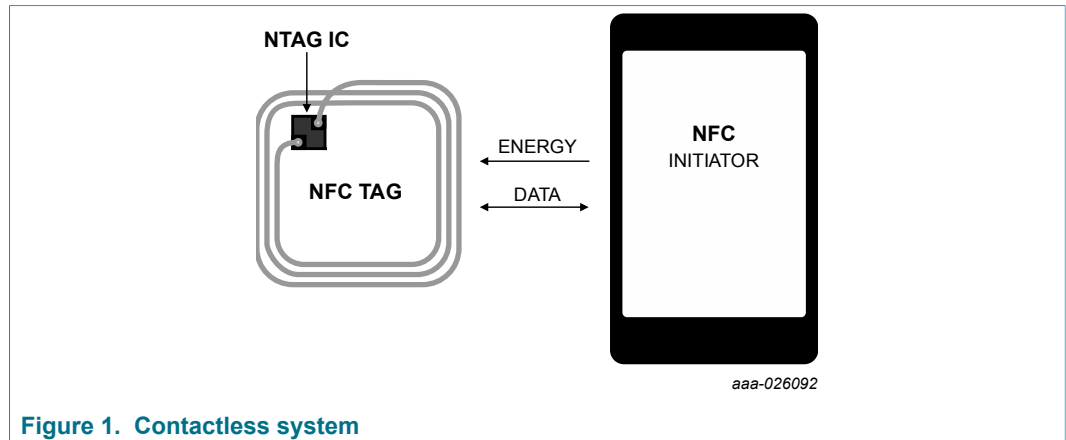


Figure 1. Contactless system

When NTAG 413 DNA is positioned in the RF field, the high speed RF communication interface allows the transmission of the data with a baud rate of up to 424 Kbit/s.

## 2 Features and benefits

### 2.1 NTAG 413 DNA features overview

#### 2.1.1 RF Interface & Communication Protocol

- Fully compliant to the ISO/IEC 14443, all parts 1 to 4, [1], [2], [3], [4]
- Fully compliant to the ISO/IEC 7816-4 [7] file selection and APDU handling
- Fully compliant passive target compliant to ISO/IEC18092 [16]
- Features 7-byte UID according to ISO/IEC14443 – 3 [3]
- Communication speed up to 424 kbps

#### 2.1.2 NFC Forum Tag Type compliance

- Fully compliant to the NFC Forum Tag 4 Type technical specification [5]
- Fully compliant to NDEF data structure configurations [6].
- Certified (Certification ID: 58515) NFC Forum Type 4 Tag, which ensures maximum interoperability [6].

#### 2.1.3 Memory organization

- One 32-byte standard data file, formatted as Capability Container (CC)
- One 128-byte standard data file for NDEF message
- Flexible mirroring of UID, NFC Counter and CMAC in the NDEF message
- Configurable separators' positions, lengths and values (or format) within the NDEF message

#### 2.1.4 Security features

- Secure Unique NFC Message (SUN)
- Three AES 128-bit application keys featuring key versions
- Incremental NFC Counter, which counts each tap

- AES based dynamic CMAC as part of the NDEF data
- Three-pass mutual authentication
- Plain, CMACed and encrypted communication (configurable)
- Secure retrieval of NFC Counter (optional)
- ECC based NXP originality signature
- Tamper-resistant secure hardware

### 2.1.5 Deployment and user convenience

NTAG 413 DNA offers the personalization of NFC tag with different type of NDEF records and a flexible setting of the NDEF file to define the mirrored parameters and CMAC input offset. At personalization of the tag, individual application keys, and accessrights to NDEF file with those keys can be set independently.

## 2.2 Crypto standard

NTAG 413 DNA's core crypto function is compliant to FIPS PUB 197 (FIPS 197) Advanced Encryption Standard (AES) [10]. CMAC is calculated according to NIST Special Publication 800-38B [11], and uses only 8 even bytes from last encrypted block.

## 2.3 NTAG 413 DNA benefits

### 2.3.1 Secure Unique NFC Message (SUN)

A cryptographical method which is generating Secure Unique NFC Message (SUN) in each tap based on [Secure Dynamic Messaging](#).

A cryptographical method which is generating Secure Unique NFC Message (SUN) in each tap based on Secure Dynamic Messaging, see the full data sheet [9].

### 2.3.2 Configuration of the Secure Unique NFC Message

Mirroring items (UID, NFC Counter, CMAC), separators' positions, lengths and values can be defined for the NDEF data. Upon the first read command within a session, the file content is generated according to the pre-defined settings and will be available thereafter. The data to be included in the CMAC calculation can be configured using an offset.

The NFC Counter is incremented on each tap and the unique response data will be generated along with a CMAC. For connecting directly to a web-service without any dedicated application on an NFC device, the NDEF data to be formatted to a URI record.

### 2.3.3 Mirroring

#### 2.3.3.1 UID

7-byte fixed UID is programmed in the chip, and can be mirrored within the NDEF message.

### 2.3.3.2 NFC Counter

A 3-byte up counter is incremented only once per each session when the NDEF file is read. This counter value can be optionally mirrored in plain into the NDEF message. Counter value can be read out encrypted after authentication by using the assigned application key as well.

### 2.3.3.3 CMAC

The 8-byte CMAC can be optionally mirrored into the NDEF message. CMAC is calculated on the defined message length. It is possible to consider only the UID and/or the NFC Counter for CMAC calculation.

### 2.3.4 Mutual authentication

NTAG 413 DNA offers 3-pass mutual authentication based on challenge response protocol with the application key. This mutual authentication enables the authentication of the tag and host ( who knows the keys) simultaneously.

### 2.3.5 ECC signature

NTAG 413 DNA offers a static ECC signature calculated on the UID of the chip. This ECC signature can be used to verify the tag's genuineness using the public key provided by NXP [\[8\]](#).

### 2.3.6 Ultimate product authentication

NTAG 413 DNA features can be integrated to design a robust product authentication. Concatenating of the multiple features e.g. ECC signature, history based UID tracking, SUN and 3-pass mutual authentication to design enhanced reliability in product authentication.

### 2.3.7 Customization from fab

NXP offers commercially the customization of the chip content (securely key injection known as trust provisioning, personalization of NDEF message and file settings). Refer to [\[13\]](#) for detail.

## 3 Applications

NTAG 413 DNA has been designed to fit in many NFC tagging applications, particularly where security is required. Several applications (but not limited) are mentioned below:

- Web-based product authentication without any application installed in NFC reader device
- In general product authentication with application installed in NFC reader device
- Access management (logical & Physical)
- Electronic voucher
- Gaming
- Consumer interaction
- Advertisement

- Campaign
- Dynamic credential for web log-in
- Document authenticity

## 4 Quick reference data

Table 1. Quick reference data

[1] [2]

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
C <sub>i</sub>	input capacitance		[3] [4]	66.5	70	73.5	pF
f <sub>i</sub>	input frequency			-	13.56	-	MHz
<b>EEPROM characteristics</b>							
t <sub>ret</sub>	retention time	T <sub>amb</sub> = 22 °C		50	-	-	year
N <sub>endu(W)</sub>	write endurance	T <sub>amb</sub> = 22 °C		200000	500 000	-	cycle
t <sub>cy(W)</sub>	write cycle time	T <sub>amb</sub> = 22 °C		-	1	-	ms

[1] Stresses above one or more of the values may cause permanent damage to the device.

[2] Exposure to limiting values for extended periods may affect device reliability.

[3] Measured with LCR meter.

[4] T<sub>amb</sub> = 22 °C; f<sub>i</sub> = 13.56 MHz; 2 V RMS

## 5 Ordering information

Table 2. Ordering information

Part number	Package		
	Name	Description	Version
NT4H1321G0DUF/xyxy	FFC Bump	8 inch wafer, 75 um thickness, on film frame carrier, electronic fail die marking according to SECS-II format), Au bumps, 160 bytes user memory, 70pF input capacitance	-
NT4H1321G0DUD/xyxy	FFC Bump	8 inch wafer, 120 um thickness, on film frame carrier, electronic fail die marking according to SECS-II format), Au bumps, 160 bytes user memory, 70pF input capacitance	-

xx = fabkey, yy = version

## 6 Block diagram

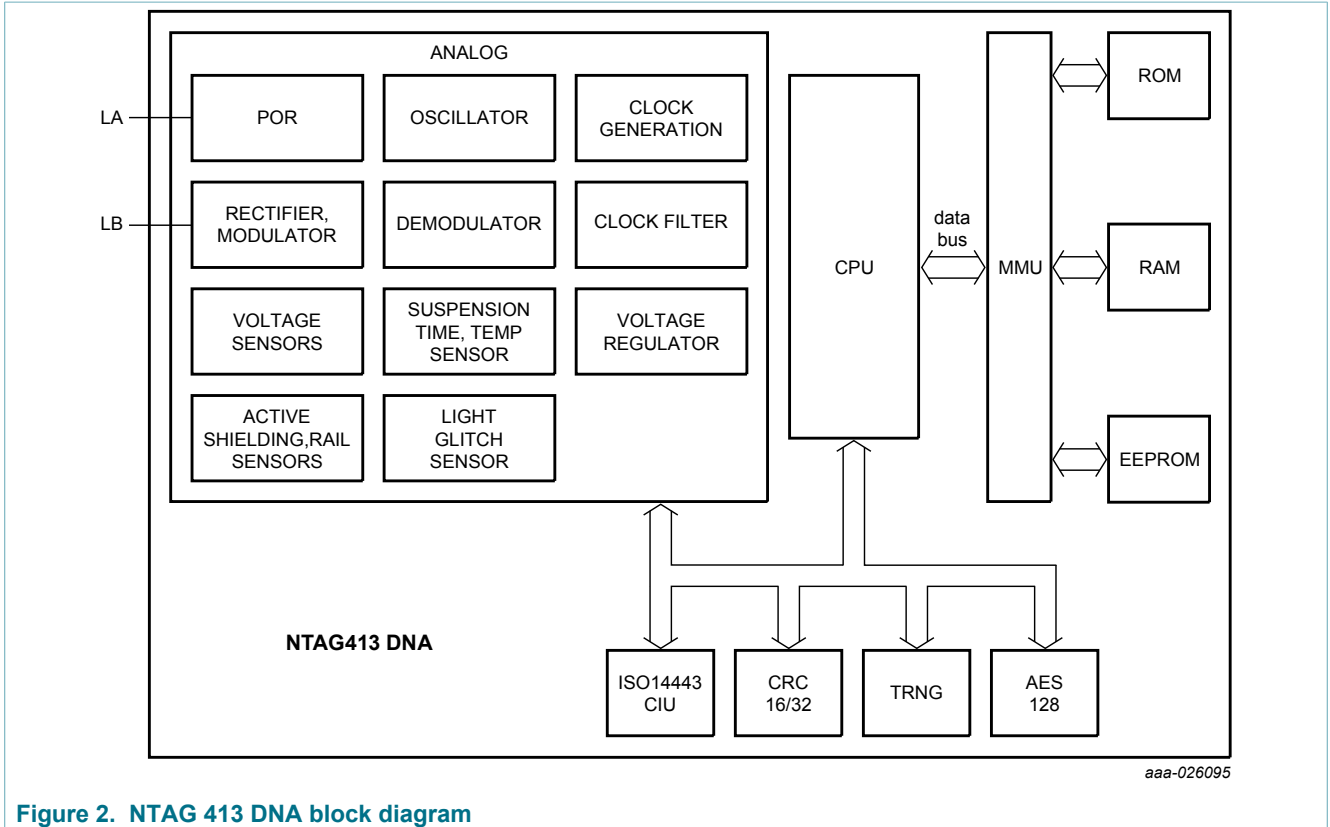


Figure 2. NTAG 413 DNA block diagram

## 7 Limiting values

Table 3. Limiting values  
[1] [2]

Symbol	Parameter	Conditions	Min	Max	Unit
$I_i$	input current		50	-	mA
$P_{tot/pack}$	total power dissipation per package		200	-	mW
$T_{stg}$	storage temperature		-55	125	°C
$T_{amb}$	ambient temperature		-25	70	°C
$V_{ESD}$	electrostatic discharge voltage	[3]	-	2	kV

[1] Stresses above one or more of the values may cause permanent damage to the device.

[2] Exposure to limiting values for extended periods may affect device reliability.

[3] MIL Standard 883-C method 3015; human body model: C = 100 pF, R = 1.5 kΩ.



read key need to be defined at NDEF personalization. At delivery no keys are defined there and hence the mirroring of UID, NFCctr, or CMAC are not activated. One-byte NDEF file ID is 0x02, is to be used as file number/ ID for the commands with class byte 0x90, wherever required

### 8.2 Communication protocol

NTAG 413 DNA uses ISO/IEC7816-4 [7] type standard APDUs for command-response pair.

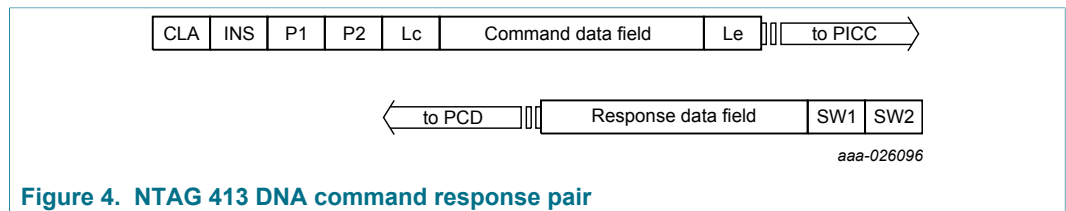


Figure 4. NTAG 413 DNA command response pair

Table 4. Command response pair

Field	Description	Length
Command header	Class byte (CLA)	1
	Instruction (INS)	1
	Parameters (P1,P2)	2
Lc field	Length of command data field (Lc), absent if no data field.	1
Command data field	Absent if no data	Lc
Le field	Expected response length.	1
Response data field	Response data if any, absent if no response data	up to Le
Response trailer	status byte (SW1SW2)	2

The field length and presence might vary for different commands, refer to the specific command description.

### 8.3 Communication modes

NTAG 413 DNA uses plain communication according to NFC Type 4 Tag operation. But it also allows encrypted and CMACed communication (especially for write) in case it is required to update the NDEF (re) personalization in field.

NTAG 413 DNA supports three communication modes. As shown in the following Table 5, the different communication modes are represented by two bits. This representation is used at several places in the document.

Table 5. Supported communication modes

Communication mode	Bit representation	Explanation
CommMode.Plain	X0	No protection: message is transmitted in clear
CommMode.MAC	01	MAC protection for integrity and authenticity



NTAG 413 DNA Secure Unique NFC Message for direct access to web services

Communication mode	Bit representation	Explanation
CommMode.Full	11	Full protection for integrity, authenticity and confidentiality

The communication mode defines the level of security for the communication between PCD and PICC.

At application and PICC level, the communication mode is defined by the command itself, as specified in the following table 7. The specified communication mode is applied if there is an active authentication regardless of whether this authentication is required by the command or not.

At file level, the communication mode is defined by the file. The specified communication mode is applied if there is an active authentication. Note however that, under an active authentication, if the only valid access condition for a certain access right is free access (0xE), CommMode.Plain is to be applied. The commands for authentication and changing keys have their own secure messaging rules, as indicated by N/A (not applicable) in Table 6. If there is no active authentication, the command and response are sent in plain (or the command is rejected in the case an authentication is required).

Table 6. Overview of expected command Communication Mode for secure messaging

Command	Communication mode
<a href="#">Cmd.AuthenticateFirst</a>	N/A (command specific)
<a href="#">Cmd.AuthenticateNonFirst</a>	N/A (command specific)
<a href="#">Cmd.ChangeFileSetting</a>	CommMode.Full
<a href="#">Cmd.ChangeKey</a>	N/A (command specific)
<a href="#">Cmd.ReadNFCCounter</a>	CommMode.Full
<a href="#">Cmd.GetFileSetting</a>	CommMode.MAC
<a href="#">Cmd.GetKeyVersion</a>	CommMode.MAC
<a href="#">Cmd.GetVersion</a>	CommMode.MAC
<a href="#">Cmd.ReadData</a>	CommMode of targeted file.
<a href="#">Cmd.SetConfiguration</a>	CommMode.Full
<a href="#">Cmd.WriteData</a>	CommMode of targeted file.

## 9 Supported commands and APDUs

Table 7. NTAG413 DNA APDUs

Command	C-APDU (hex)							R-APDU		
	INS	CLA	INS	P1	P2	Lc	Data	Le	Data	SW1 SW2
<a href="#">Cmd.SELECT</a>	00	A4	XX	XX	XX	Data to send	XX	XX	response	9000
<a href="#">Cmd.READ BINARY</a>	00	B0	XX	XX	-	-	XX	XX	response	9000
<a href="#">Cmd.UPDATE BINARY</a>	00	D6	XX	XX	XX	Data to write	-	-	-	9000
<a href="#">Cmd.AuthenticateFirst</a>	90	71	00	00	XX	Reference data	00	00	Data	9100
<a href="#">Cmd.AuthenticateNonFirst</a>	90	77	00	00	XX	Data	00	00	Data	9100
<a href="#">Cmd.ChangeFileSetting</a>	90	5F	00	00	XX	Data	00	00	Data	9100

## NTAG 413 DNA Secure Unique NFC Message for direct access to web services

Command	C-APDU (hex)							R-APDU	
<a href="#">Cmd.GetFileSetting</a>	90	F5	00	00	01	File number	00	Data	9100
<a href="#">Cmd.ChangeKey</a>	90	C4	00	00	xx	data	00	data	9100
<a href="#">Cmd.GetKeyVersion</a>	90	64	00	00	01	Key number	00	Data	9100
<a href="#">Cmd.GetVersion</a>	90	60	00	00	-	-	00	Data	9100
<a href="#">Cmd.ReadNFCCounter</a>	90	F6	00	00	01	02	00	Counter	9100
<a href="#">Cmd.ReadData</a>	90	AD	00	00	XX	Reference	00	Data	9100
<a href="#">Cmd.WriteData</a>	90	8D	00	00	XX	Data	00	Data	9100
<a href="#">Cmd.SetConfiguration</a>	90	5C	00	00	01	File number	00	Data	9100
<a href="#">Cmd.Read_Sig</a>	90	3C	00	00	01	Signature	00	Data	9190

For details of the APDUs and the values see the full data sheet [\[9\]](#).

## 10 Abbreviations

Table 8. Abbreviations

Acronym	Description
AES	Advanced Encryption Standard
AID	Application Identifier
APDU	Application Protocol Data Unit
C-APDU	Command APDU
CC	Capability Container
CLA	Class
CMAC	Cipher-based Message Authentication Code
CRC	Cyclic Redundancy Check
Ctr	Counter
DF	Dedicated File
ECC	Elliptic Curve Cryptography
INS	Instructions
MAC	Message Authentication Code
NFC	Near Field Communication
NDEF	NFC Data Exchange Format
POS	Point Of Service
PICC	Proximity IC Card
R-APDU	Response APDU
RID	Registered ID
SDM	<a href="#">Secure Dynamic Messaging</a>
SSM	<a href="#">Standard Secure Messaging</a>
SUN	Secure Unique NFC Message
UID	Unique Identifier

## 11 References

- [1] ISO/IEC 14443-1:2016, Identification cards -- Contactless integrated circuit cards -- Proximity cards -- Part 1: Physical characteristics
- [2] ISO/IEC 14443-2:2016, Identification cards -- Contactless integrated circuit cards -- Proximity cards -- Part 2: Radio frequency power and signal interface
- [3] ISO/IEC 14443-3:2016, Identification cards -- Contactless integrated circuit cards -- Proximity cards -- Part 3: Initialization and anti-collision
- [4] ISO/IEC 14443-4:2016, Identification cards -- Contactless integrated circuit cards -- Proximity cards -- Part 4: Transmission protocol
- [5] NFC Forum Type 4 Tag Operation Specification 2.0, Technical Specification, T4TOP 2.0, NFCForum-TS-Type-4-Tag\_2.0, 2011
- [6] NFC Data Exchange Format (NDEF), Technical Specification — NFC Forum, 24.07.2006, Version 1.0
- [7] ISO JTC 1/SC 27 Identification cards – Integrated circuit cards – Part 4: Organization, security and commands for interchange. ISO/IEC 7816-4:2005, January 2005.
- [8] Application note - NTAG 413 DNA Feature and Hints, doc number 4103xx. available from NXP doc store.
- [9] NTAG 413 DNA full data sheet, document number 400310, available from NXP doc store.
- [10] National Institute of Standards and Technology (NIST), Specification for the Advanced Encryption Standard (AES). Federal Information Processing Standards Publication 197, November 2001.
- [11] NIST Special Publication 800-38B - Recommendation for Block, Cipher Modes of Operation: The CMAC Mode for Authentication. [http://csrc.nist.gov/publications/nistpubs/800-38B/SP\\_800-38B.pdf](http://csrc.nist.gov/publications/nistpubs/800-38B/SP_800-38B.pdf).
- [12] NTAG antenna design application note. [http://www.nxp.com/products/identification-and-security/nfc-and-reader-ics/connected-tag-solutions/ntag-ic-plus-explorer-kit-demo-kit:OM5569-NT322E?fpsp=1&tab=Documentation\\_Tab#nogo](http://www.nxp.com/products/identification-and-security/nfc-and-reader-ics/connected-tag-solutions/ntag-ic-plus-explorer-kit-demo-kit:OM5569-NT322E?fpsp=1&tab=Documentation_Tab#nogo)
- [13] Application note - NTAG 413 DNA Personalization at fab, doc number 4124xx. available from NXP doc store
- [14] NIST Special Publication 800-38B Recommendation for Block Cipher Modes of Operation: The CMAC Mode for Authentication. [http://csrc.nist.gov/publications/nistpubs/800-38B/SP\\_800-38B.pdf](http://csrc.nist.gov/publications/nistpubs/800-38B/SP_800-38B.pdf).
- [15] NFC Forum Type 4 Tag Operation Specification 2.0, Technical Specification, T4TOP 2.0, NFCForum-TS-Type-4-Tag\_2.0, 2011
- [16] ISO/IEC 18092:2013 - Information technology -- Telecommunications and information exchange between systems -- Near Field Communication -- Interface and Protocol (NFCIP-1)

## 12 Revision history

Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NT4H1321_SDS v. 3.2	20171012	Product short data sheet	-	NT4H1321_SDS v. 3.1
Modifications:	• NFC Forum certification added			

NTAG 413 DNA Secure Unique NFC Message for direct access to web services

Document ID	Release date	Data sheet status	Change notice	Supersedes
NT4H1321_SDS v. 3.1	20170601	Product short data sheet	-	NT4H1321_SDS v. 3.0
Modifications:	<ul style="list-style-type: none"> <li>• <a href="#">Section 2.1.1</a> "Communication speed up to 424 kbps" added</li> <li>• <a href="#">Table 1</a>: retention time changed into 50 years</li> </ul>			
NT4H1321_SDS v. 3.0	20170508	Product short data sheet	-	NT4H1321_SDS v. 1.0
Modifications:	<ul style="list-style-type: none"> <li>• Data sheet status changed into "Product short data sheet"</li> </ul>			
NT4H1321_SDS v. 1.0	20170329	Objective short data sheet	-	-

[1] Stresses above one or more of the values may cause permanent damage to the device.  
 [2] Exposure to limiting values for extended periods may affect device reliability.

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Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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**Tables**

Tab. 1.	Quick reference data .....	5	Tab. 6.	Overview of expected command Communication Mode for secure messaging ....	9
Tab. 2.	Ordering information .....	5	Tab. 7.	NTAG413 DNA APDUs .....	9
Tab. 3.	Limiting values .....	6	Tab. 8.	Abbreviations .....	10
Tab. 4.	Command response pair .....	8	Tab. 9.	Revision history .....	11
Tab. 5.	Supported communication modes .....	8			

**Figures**

Fig. 1.	Contactless system .....	2	Fig. 3.	NDEF Application with default setting .....	7
Fig. 2.	NTAG 413 DNA block diagram .....	6	Fig. 4.	NTAG 413 DNA command response pair .....	8

Contents

**1 Introduction ..... 1**

1.1 Contactless energy and data transfer .....1

**2 Features and benefits .....2**

2.1 NTAG 413 DNA features overview .....2

2.1.1 RF Interface & Communication Protocol .....2

2.1.2 NFC Forum Tag Type compliance ..... 2

2.1.3 Memory organization .....2

2.1.4 Security features .....2

2.1.5 Deployment and user convenience ..... 3

2.2 Crypto standard .....3

2.3 NTAG 413 DNA benefits ..... 3

2.3.1 Secure Unique NFC Message (SUN) .....3

2.3.2 Configuration of the Secure Unique NFC Message ..... 3

2.3.3 Mirroring .....3

2.3.3.1 UID .....3

2.3.3.2 NFC Counter ..... 4

2.3.3.3 CMAC ..... 4

2.3.4 Mutual authentication .....4

2.3.5 ECC signature ..... 4

2.3.6 Ultimate product authentication ..... 4

2.3.7 Customization from fab .....4

**3 Applications .....4**

**4 Quick reference data ..... 5**

**5 Ordering information ..... 5**

**6 Block diagram ..... 6**

**7 Limiting values .....6**

**8 Functional description .....7**

8.1 File system ..... 7

8.1.1 Keys .....7

8.1.2 CC file .....7

8.1.3 NDEF file ..... 7

8.2 Communication protocol ..... 8

8.3 Communication modes ..... 8

**9 Supported commands and APDUs .....9**

**10 Abbreviations ..... 10**

**11 References ..... 11**

**12 Revision history ..... 11**

**13 Legal information ..... 13**

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